March 2013

# FDPF085N10A

## N-Channel PowerTrench® MOSFET

**100 V, 40 A, 8.5 mΩ**

## Features

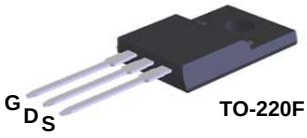
- $R_{DS(on)}$ = 6.5 mΩ ( Typ.)@ $V_{GS}$ = 10V, $I_D$ = 40A
- Fast Switching Speed
- Low Gate Charge, $Q_G$ = 31 nC(Typ.)
- High Performance Trench Technology for Extremely Low $R_{DS(on)}$
- High Power and Current Handling Capability
- RoHS Compliant

## General Description

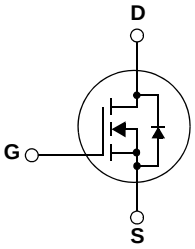
This N-Channel MOSFET is produced using Fairchild Semiconductor®'s advance PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

## Applications

- Consumer Appliances
- LED TV
- Synchronous Rectification for ATX / Sever / Telecom PSU
- Motor Drives and Uninterruptible Power Supplies
- Micro Solar Inverter




TO-220F




## MOSFET Maximum Ratings $T_C$ = 25°C unless otherwise noted

| Symbol | Parameter | | | FDPF085N10A | Unit |
|---|---|---|---|---|---|
| $V_{DSS}$ | Drain to Source Voltage | | | 100 | V |
| $V_{GSS}$ | Gate to Source Voltage | | | ±20 | V |
| $I_D$ | Drain Current | -Continuous ($T_C$ = 25°C) | | 40 | A |
| | | -Continuous ($T_C$ = 100°C) | | 28 | |
| $I_{DM}$ | Drain Current | - Pulsed | (Note 1) | 160 | A |
| $E_{AS}$ | Single Pulsed Avalanche Energy | | (Note 2) | 269 | mJ |
| dv/dt | Peak Diode Recovery dv/dt | | (Note 3) | 6.0 | V/ns |
| $P_D$ | Power Dissipation | ($T_C$ = 25°C) | | 33.3 | W |
| | | - Derate above 25°C | | 0.22 | W/°C |
| $T_J$, $T_{STG}$ | Operating and Storage Temperature Range | | | -55 to +175 | °C |
| $T_L$ | Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds | | | 300 | °C |

## Thermal Characteristics

| Symbol | Parameter | FDPF085N10A | Unit |
|---|---|---|---|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 4.5 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5 | |

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## Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|---|---|---|---|---|---|
| FDPF085N10A | FDPF085N10A | TO-220F | - | - | 50 |

## Electrical Characteristics $T_C = 25^oC$ unless otherwise noted

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| **Off Characteristics** | | | | | | |
| $BV_{DSS}$ | Drain to Source Breakdown Voltage | $I_D$ = 250μA, $V_{GS}$ = 0V | 100 | - | - | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature Coefficient | $I_D$ = 250μA, Referenced to 25°C | - | 0.07 | - | V/°C |
| $I_{DSS}$ | Zero Gate Voltage Drain Current | $V_{DS}$ = 80V, $V_{GS}$ = 0V | - | - | 1 | μA |
| | | $V_{DS}$ = 80V, $T_C$ = 150°C | - | - | 500 | |
| $I_{GSS}$ | Gate to Body Leakage Current | $V_{GS}$ = ±20V, $V_{DS}$ = 0V | - | - | ±100 | nA |
| **On Characteristics** | | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}$ = $V_{DS}$, $I_D$ = 250μA | 2.0 | - | 4.0 | V |
| $R_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS}$ = 10V, $I_D$ = 96A | - | 6.5 | 8.5 | mΩ |
| $g_{FS}$ | Forward Transconductance | $V_{DS}$ = 10V, $I_D$ = 96A | - | 76 | - | S |
| **Dynamic Characteristics** | | | | | | |
| $C_{iss}$ | Input Capacitance | $V_{DS}$ = 50V, $V_{GS}$ = 0V, f = 1MHz | - | 2025 | 2695 | pF |
| $C_{oss}$ | Output Capacitance | | - | 468 | 620 | pF |
| $C_{rss}$ | Reverse Transfer Capacitance | | - | 20 | - | pF |
| $C_{oss}$(er) | Engry Related Output Capacitance | $V_{DS}$ = 50V, $V_{GS}$ = 0V | - | 752 | - | pF |
| $Q_{g(tot)}$ | Total Gate Charge at 10V | $V_{GS}$ = 10V, $V_{DS}$ = 50V, $I_D$ = 96A (Note 4) | - | 31 | 40 | nC |
| $Q_{gs}$ | Gate to Source Gate Charge | | - | 9.7 | - | nC |
| $Q_{gs2}$ | Gate Charge Threshoid to Plateau | | - | 5.0 | - | nC |
| $Q_{gd}$ | Gate to Drain “Miller” Charge | | - | 7.5 | - | nC |
| ESR | Equivalent Series Resistance (G-S) | f = 1MHz | - | 0.97 | - | Ω |
| **Switching Characteristics** | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD}$ = 50V, $I_D$ = 96A, $V_{GS}$ = 10V, $R_{GEN}$ = 4.7Ω (Note 4) | - | 18 | 46 | ns |
| $t_r$ | Turn-On Rise Time | | - | 22 | 54 | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | - | 29 | 68 | ns |
| $t_f$ | Turn-Off Fall Time | | - | 8 | 26 | ns |
| **Drain-Source Diode Characteristics** | | | | | | |
| $I_S$ | Maximum Continuous Drain to Source Diode Forward Current | | - | - | 40 | A |
| $I_{SM}$ | Maximum Pulsed Drain to Source Diode Forward Current | | - | - | 160 | A |
| $V_{SD}$ | Drain to Source Diode Forward Voltage | $V_{GS}$ = 0V, $I_{SD}$ = 96A | - | - | 1.3 | V |
| $t_{rr}$ | Reverse Recovery Time | $V_{DD}$ = 50V,$V_{GS}$ = 0V, $I_{SD}$ = 96A, $dI_F/dt$ = 100A/μs | - | 59 | - | ns |
| $Q_{rr}$ | Reverse Recovery Charge | | - | 80 | - | nC |

**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. L = 3 mH, $I_{AS}$ = 13.4 A, $R_G$ = 25Ω, Starting $T_J$ = 25°C
3. $I_{SD}$ ≤ 40 A, di/dt ≤ 200A/μs, $V_{DD}$ ≤ $BV_{DSS}$, Starting $T_J$ = 25°C
4. Essentially Independent of Operating Temperature Typical Characteristics

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## Typical Performance Characteristics

**Figure 1. On-Region Characteristics**

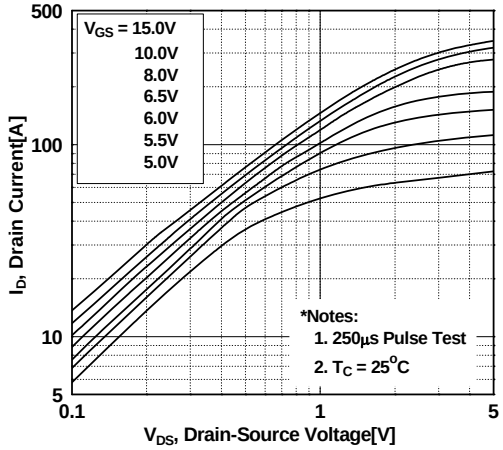



**Figure 2. Transfer Characteristics**

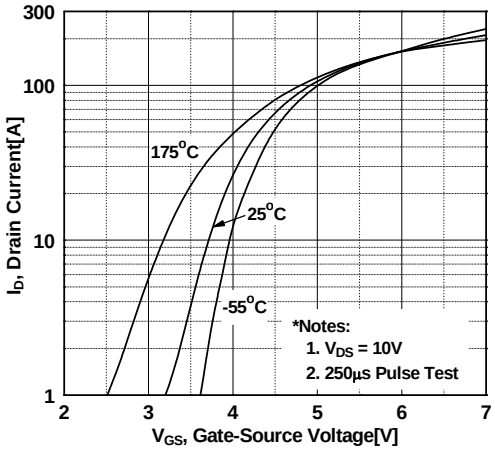



**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**

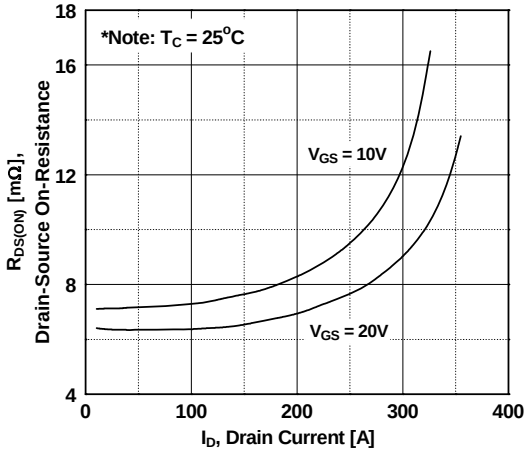



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

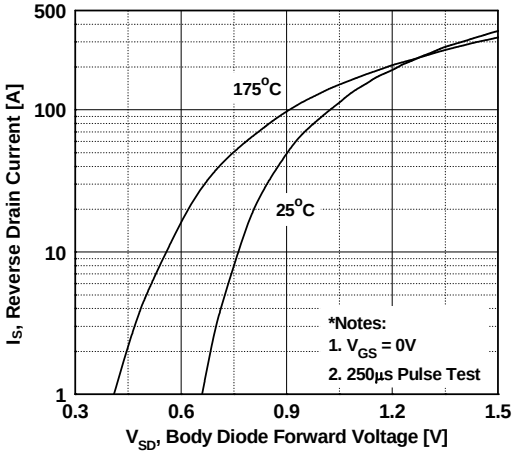



**Figure 5. Capacitance Characteristics**

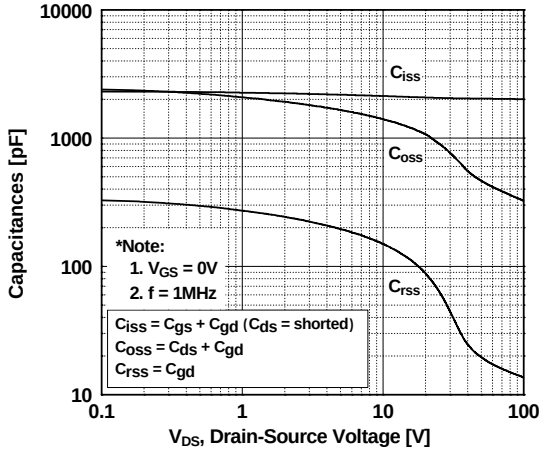
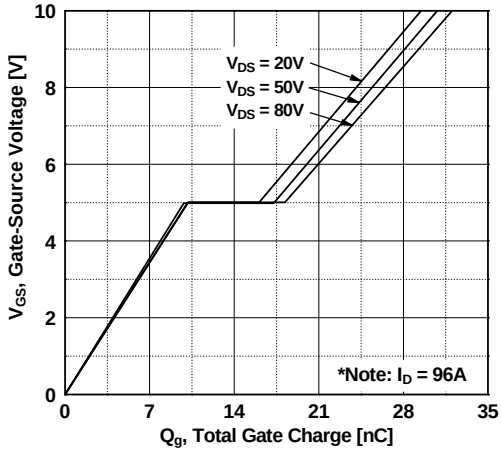



**Figure 6. Gate Charge Characteristics**

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## Typical Performance Characteristics (Continued)

**Figure 7. Breakdown Voltage Variation vs. Temperature**

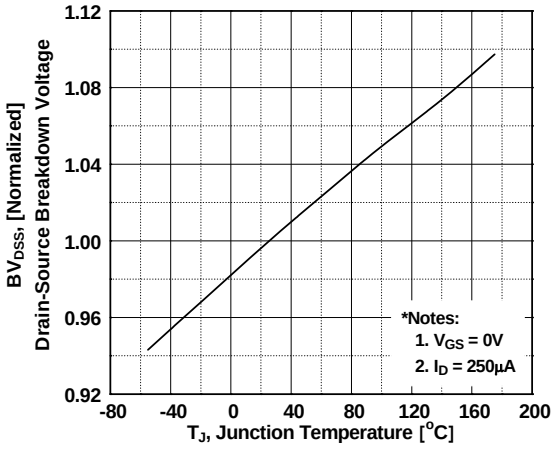



**Figure 8. On-Resistance Variation vs. Temperature**

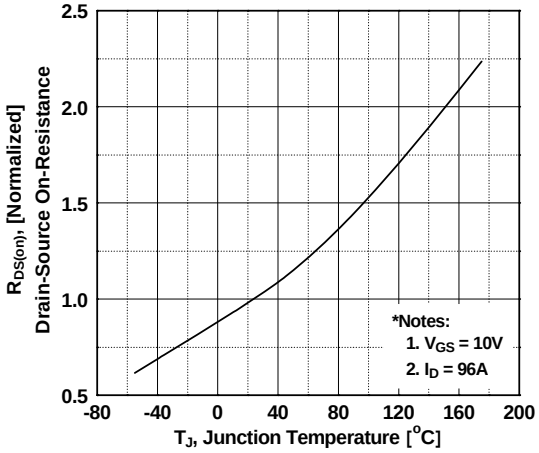



**Figure 9. Maximum Safe Operating Area**

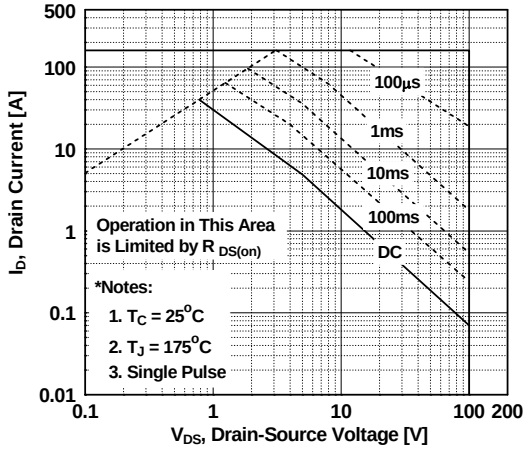



**Figure 10. Maximum Drain Current vs. Case Temperature**

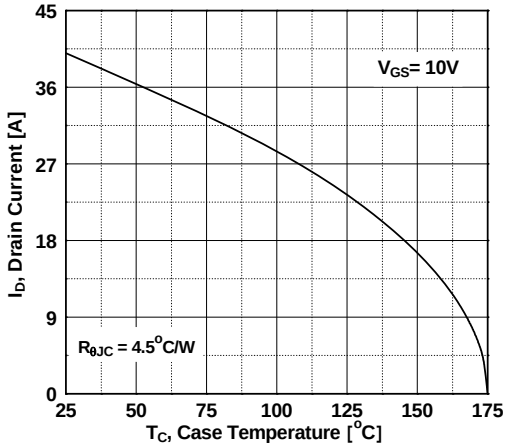



**Figure 11. Eoss vs. Drain to Source Voltage**

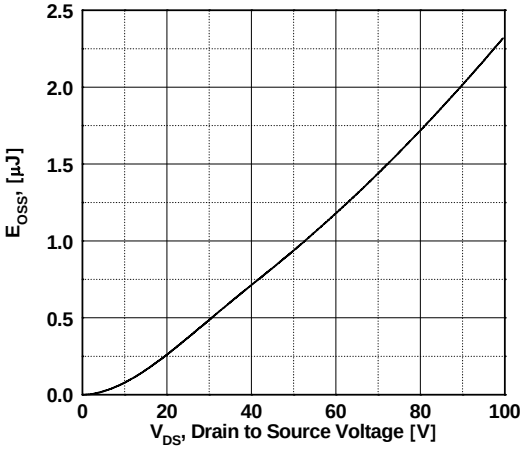
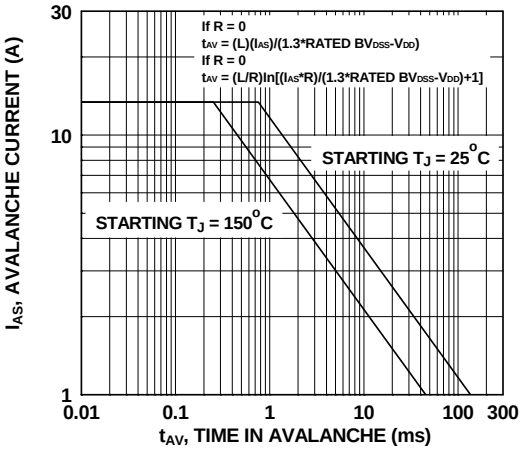



**Figure 12. Unclamped Inductive Switching Capability**

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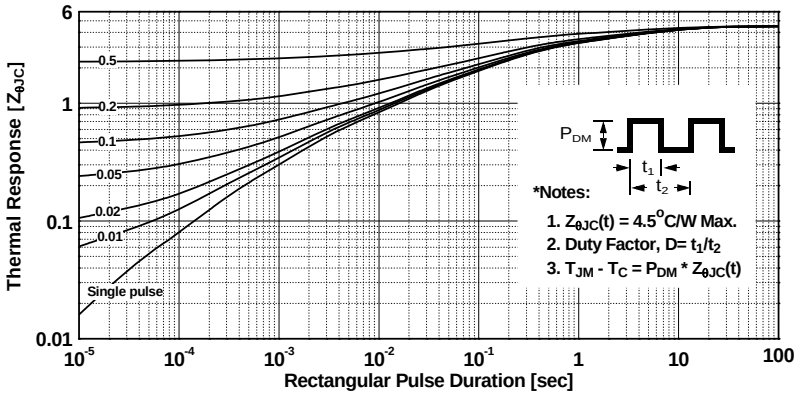
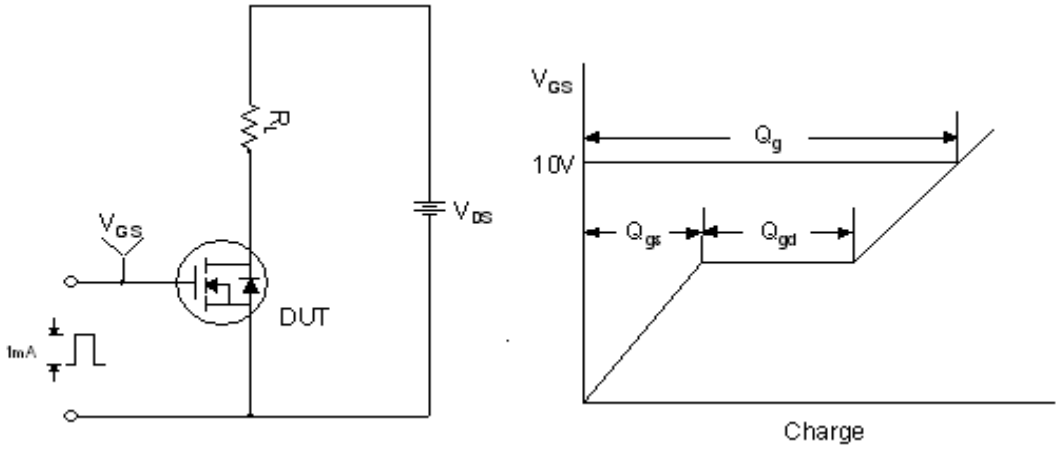
## Typical Performance Characteristics (Continued)

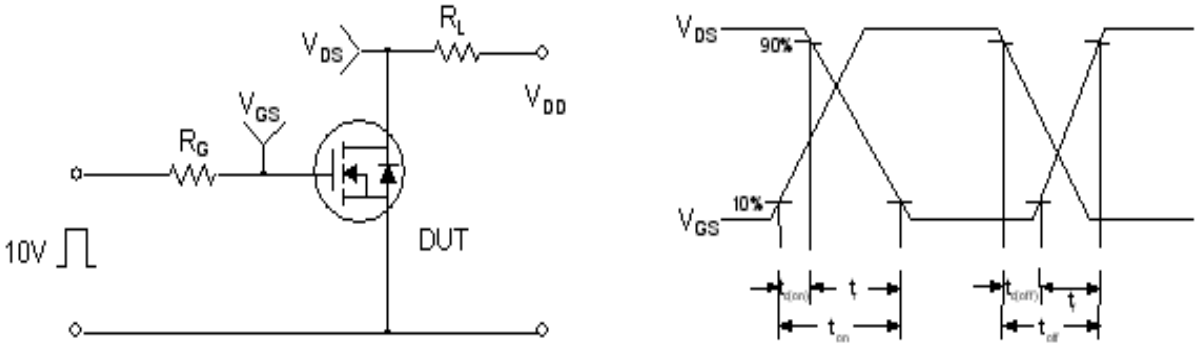
**Figure 13. Transient Thermal Response Curve**



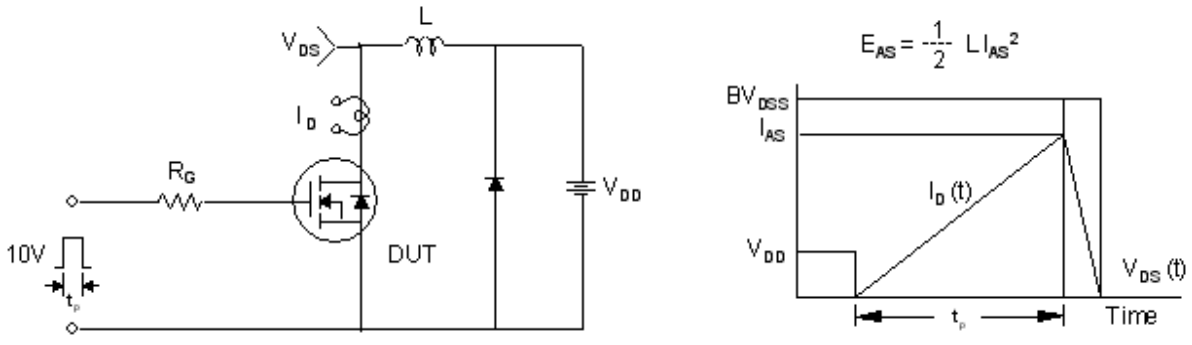
**Gate Charge Test Circuit & Waveform**



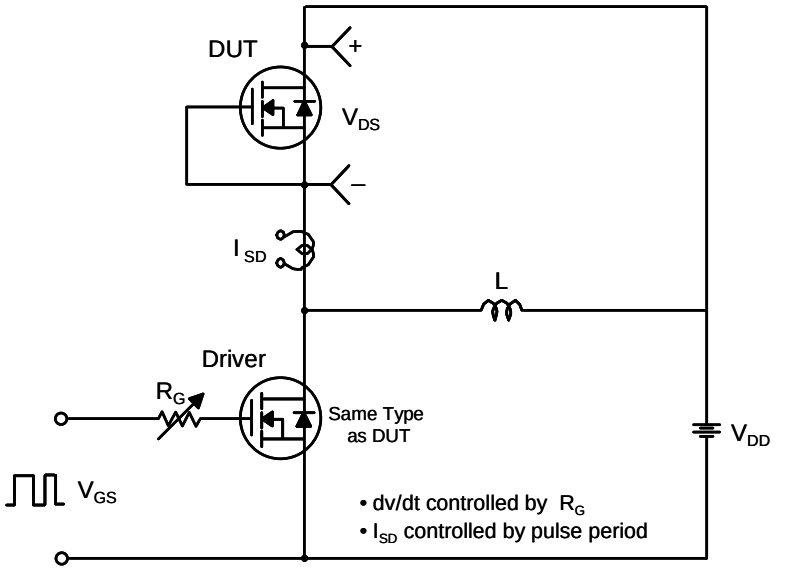

**Resistive Switching Test Circuit & Waveforms**

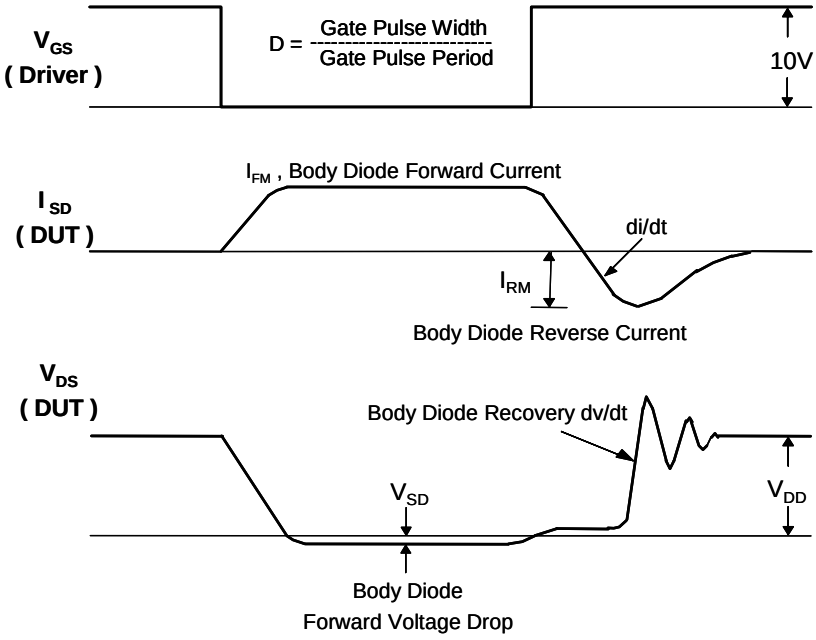



**Unclamped Inductive Switching Test Circuit & Waveforms**



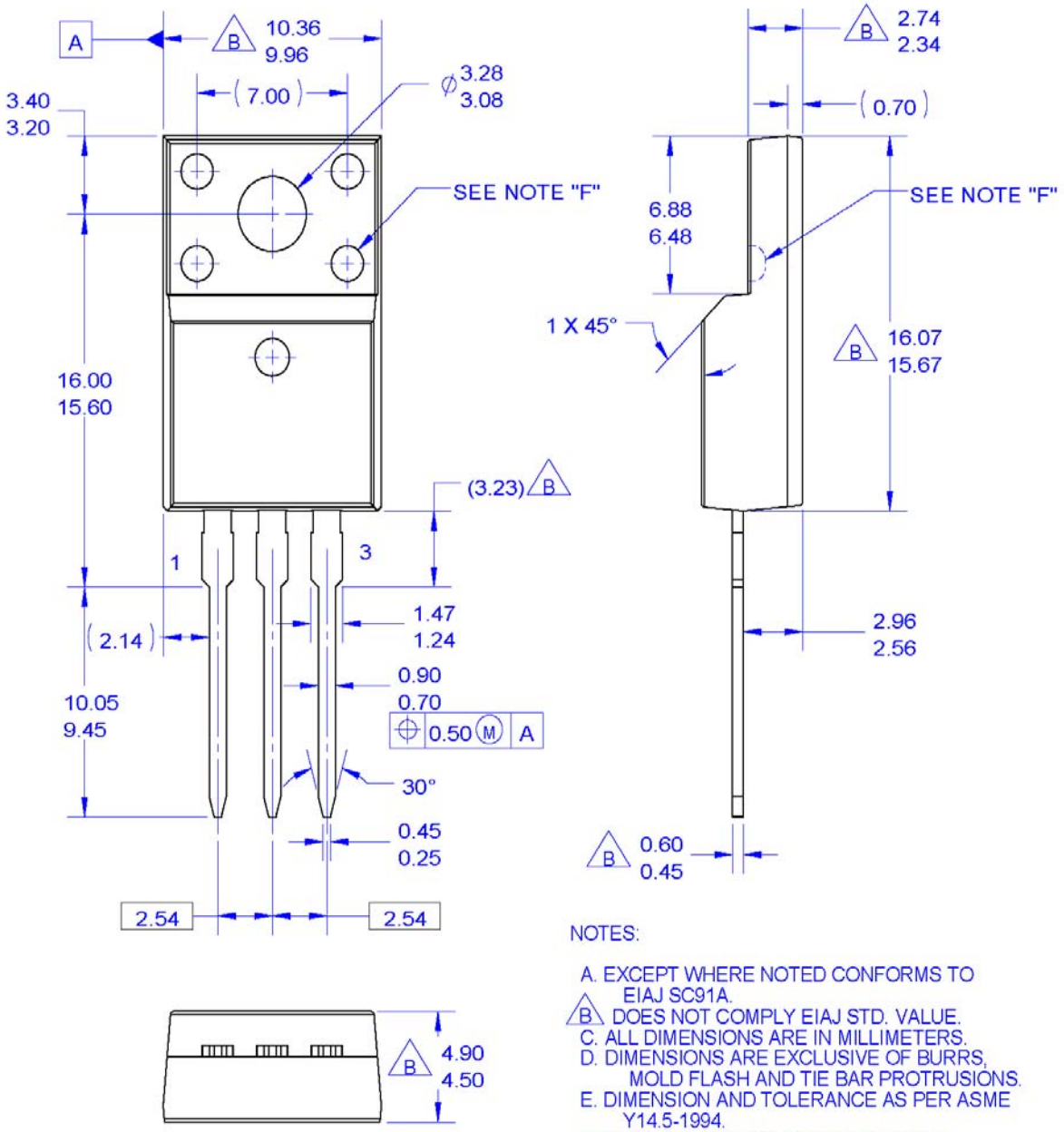
**Peak Diode Recovery dv/dt Test Circuit & Waveforms**



## Mechanical Dimensions

# TO-220M03




NOTES:

A. EXCEPT WHERE NOTED CONFORMS TO EIAJ SC91A.
B. DOES NOT COMPLY EIAJ STD. VALUE.
C. ALL DIMENSIONS ARE IN MILLIMETERS.
D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
F. OPTION 1 - WITH SUPPORT PIN HOLE.
OPTION 2 - NO SUPPORT PIN HOLE.
G. DRAWING FILE NAME: TO220M03REV3

Dimensions in Millimeters

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|---|---|---|
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